

SPECIFICATION FOR LCD MODULE

MODULE NO: YB-TG480272S12A-N-D0

Doc.Version:01

Customer Approv	val:		
☐ Accept			☐ Reject
YEEBO	NAME	SIGNATURE	DATE
Prepare	Electronic Engineer		2016-9.10
Check	Mechanical Engineer	楊仁孝	2016.9.10
Verify		宴之乱	2016.9.10
Approval		礁黑仡	2016.9.10
☐ APPROVAL	FOR SPECIFICATIONS (ONLY	
■ APPROVAL	FOR SPECIFICATIONS A	AND SAMPLE	

WIMRD005-02-D

Add: 7/F.,On Dak Industrial Building,2-6 Wah Sing Street, Kwai Chung,H.K. Tel: +852-2945-6800; +852-2945-6885

Fax: +852-2481-0019



1. Revision History

Sample Version	DOC. Version	DATE		DESCRIPTION			
D0	00	2016-07-22	SPEC ONLY	First issue	Shien / Yang		
D0	01	2016-09-10	SPEC ONLY	First sample	Shien / Yang		



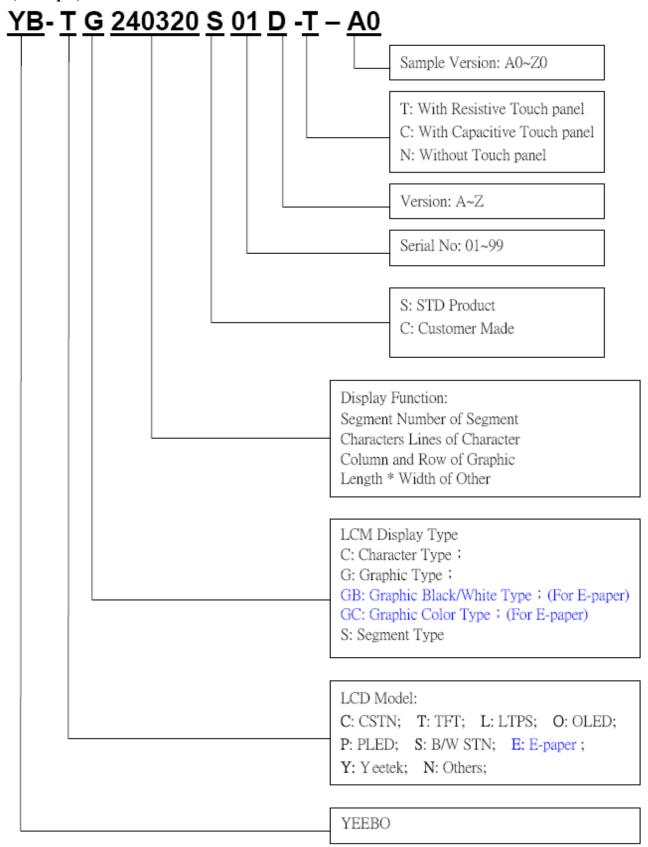
2. Table of Contents:

NO	CONTENTS	PAGE
1	Revision History	1
2	Table of Contents	2
3	Module Numbering System	3
4	General Specification	4
5	LCM drawing	5
6	Electrical Characteristics	6
7	Optical Characteristics	10
8	Interface Pin Assignment	12
9	Block Diagram	13
10	Backlight	14
11	Standard Specification for Reliability	15
12	Specification of Quality Assurance	17
13	Handing Precaution	25
14	Guarantee	25



3. Module Numbering System:

(Example)



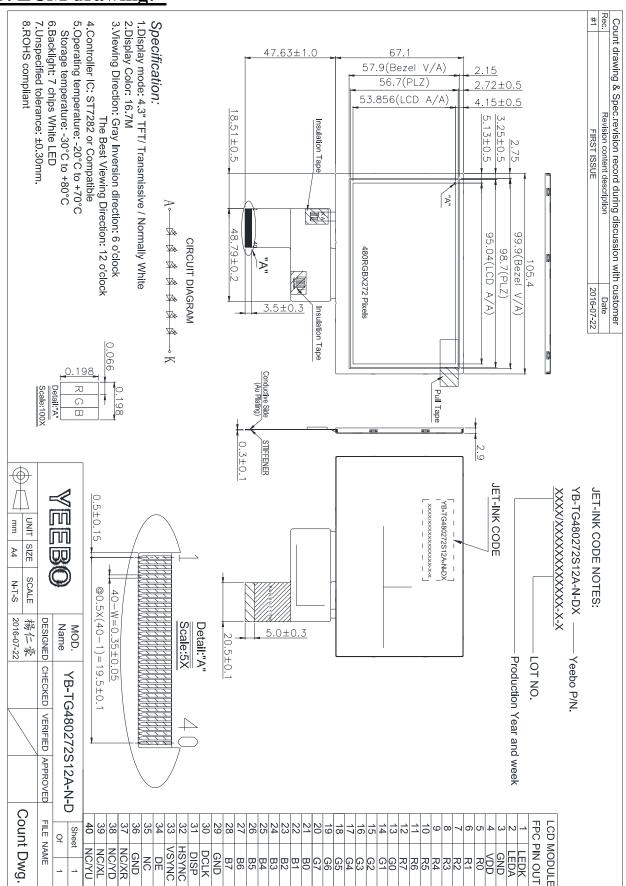


4. General Specification:

ITEM	CONTENTS			
Module Size	105.4 (W) *67.1 (H) *2.9 (T) mm			
Module Size(With FPC)	105.4 (W) * 114.73(H) * 2.9(T) mm			
Display Size(Diagonal)	4.3 inch			
Display Format	480(RGB)* 272 Pixels			
Active Area	95.04(W) * 53.856(H) mm			
Dots Pitch	0.198*0.198 mm			
LCD Type	TFT (16.7M)/ Transmissive / Normal White			
Viewing Direction (Gray inversion)	6 O'clock			
The Best Viewing Direction	12 O'clock			
Controller IC	ST7282			
Weight	43g.			



5. LCM drawing:





6. Electrical Characteristics

6-1 Absolute Maximum Ratings

 $(Ta=25^{\circ}C\ VSS=0V)$

Item	Symbol	Min.	Туре	Max.	Unit	Remark
Power Supply voltage	VDD	-0.5		+4.6	Volt	
Operating Temperature	Topr	-20	-	70	$^{\circ}$ C	
Storage Temperature	Tstg	-30	-	80	$^{\circ}\!\mathbb{C}$	

Note1: Absolute maximum rating is the limit value beyond which the IC maybe broken. They do not assure operations.

6-2 Operating Conditions

(Ta=25°C)

1 0					•	• ,
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply voltage	VDD	-	3.0	3.3	3.6	Volt
Level Input Voltage	VIH	-	0.7*VDD	-	VDD	Volt
Level input voltage	VIL	-	GND		0.3*VDD	Volt
Power Supply Current for LCM	IDD	-	-	24	36	mA

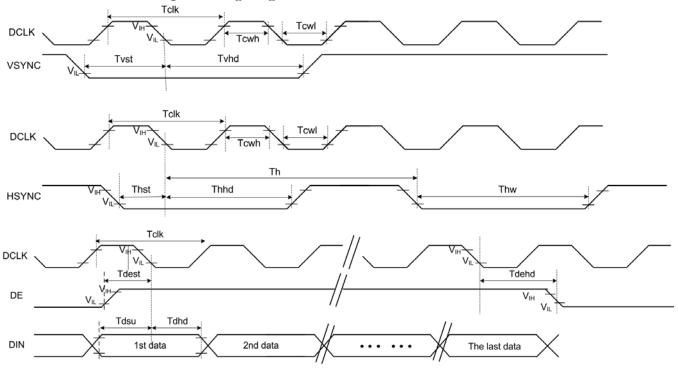
Note1:GND=0V

Module P/N: YB-TG480272S12A-N-D0 Doc.Version:01 6



6-3 Timing Characteristics

6-3-1Clock and data input timing diagram





6-3-2RGB input timing table

6-3-2-1 Parallel 24-bit RGB timing table

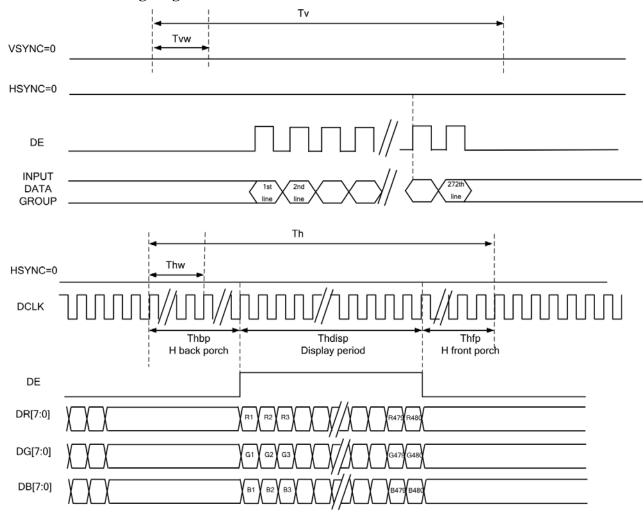
Item		Symbol	Min.	Тур.	Max.	Unit	Remark
DCLK Fred	quency	Fclk	8	9	12	MHz	
DCLK Peri	od	Tclk	83	111	125	ns	
HSYNC	Period Time	Th	485	531	598	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	3	43	43	DCLK	By H_Blanking setting
	Front Porch	Thfp	2	8	75	DCLK	
	Pulse Width	Thw	2	4	75	DCLK	
VSYNC	Period Time	Tv	276	292	321	Н	
	Display Period	Tvdisp		272		Н	
	Back Porch	Tvbp	2	12	12	Н	By V_Blanking setting
	Front Porch	Tvfp	2	8	37	Н	
	Pulse Width	Tvw	2	4	37	Н	

Note: It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

Module P/N: YB-TG480272S12A-N-D0 Doc.Version:01 8



6-3-3 DE mode timing diagram





7. Optical Characteristics:

Itaan	Item		Canditions	Spe	cification	ons	TI:4	Note	
Iten	1	Symbol	Conditions	Min	Тур	Max	Unit	Note	
Transmit	ttance	T(%)	_	-	5.9	-	-	-	
Contrast	Ratio	CR	⊕=0 Normal Viewing angle	250	350	-		(1) (2)	
Response	e time	TR+TF	_	-	30	45	ms	(1) (3)	
	Hor.	Θ x+		-	75	-			
Viewin	Viewin g angle Ver.	Өх-	CR≧10	-	75	-	doa		
g angle		Өу+	$O_{\rm K} = 10$	-	60	-	deg.	-	
	vei.	Өу-		-	70	-			

Measuring Condition

1. Measuring surrounding: dark room 2. Ambient temperature: 25±2°C

3. 30 min. Warm-up time.

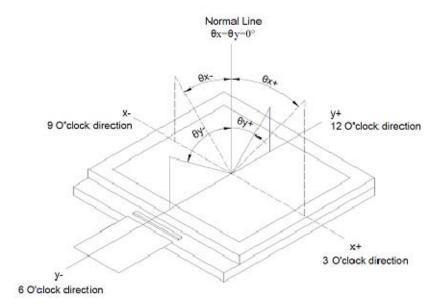
Color of CIE Coordinate:

Item		Symbol	Condition	Min.	Тур.	Max.
	D. I	х		0.541	0.591	0.641
	Red	у	θ = 0° Backlight Color Degree	0.292	0.342	0.392
	Green	х		0.301	0.351	0.401
Chromaticity Coordinates		у		0.553	0.603	0.653
(Transmissive)	Blue	х		0.109	0.159	0.209
(Transmissive)		у		0.093	0.143	0.193
		Х		0.277	0.327	0.377
	White	у		0.318	0.368	0.418

Module P/N: YB-TG480272S12A-N-D0 Doc.Version:01



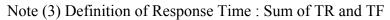
Note (1) Definition of Viewing Angle:

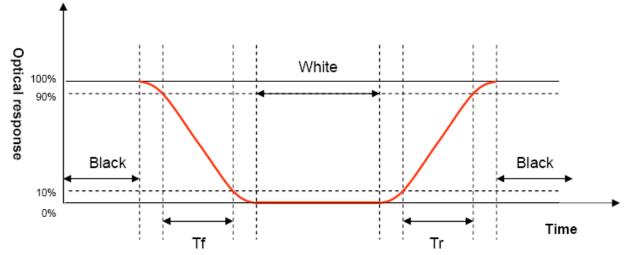


Note (2) Definition of Contrast Ratio(CR): measured at the center point of panel

Contrast ratio (CR)= Photo detector output when LCD is at "White" state

Photo detector output when LCD is at "Black





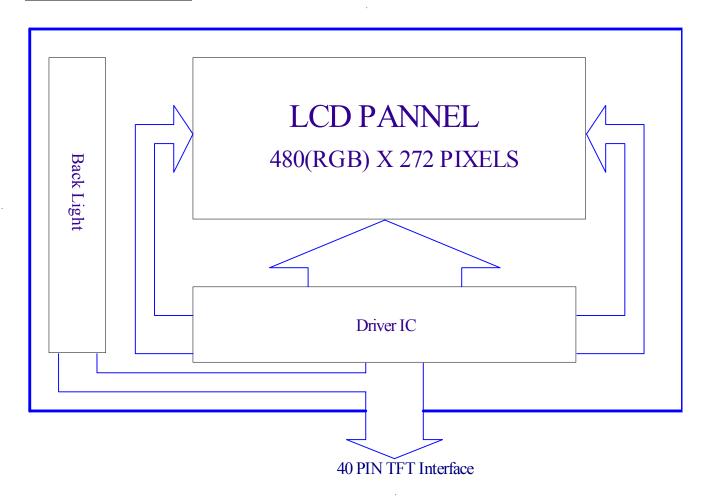


8. Interface Pin Assignment:

No.	Symbol	Function
1	LEDK	Cathode of LED backlight
2	LEDA	Anode of LED backlight
3	GND	GND Power ground
4	VDD	Power voltage.
5~12	R0∼ R7	Digital data input.R0(LSB),R7(MSB)
13~20	G0~ G7	Digital data input.G0(LSB),G7(MSB)
21~28	B0∼ B7	Digital data input.B0(LSB),B7(MSB)
29	GND	Power ground
30	DCLK	Data clock signal input
31	DISP	Display on/off mode control. (a) DISP=L, standby mode. (b) DISP=H, normal display mode.
32	HSYNC	Horizontal sync signal input
33	VSYNC	Vertical sync signal input
34	DE	Data enable input.
35	NC	No connection
36	GND	Power ground
37	NC/XR	No connection, reserve for TP interface.
38	NC/YD	No connection, reserve for TP interface.
39	NC/XL	No connection, reserve for TP interface.
40	NC/YU	No connection, reserve for TP interface.
	-	•



9. Block Diagram:





10. Backlight:

- 1. Standard Lamp Styles (Edge Lighting Type):
 The LED chips are distributed over the edge light area of the illumination unit, which gives the less power consumption:
- 2. The Main Advantages of the LED Backlight are as following:
 - 2.1 The brightness of the backlight can simply be adjusted. By a resistor or a potentiometer.

3. Data About LED Backlight:

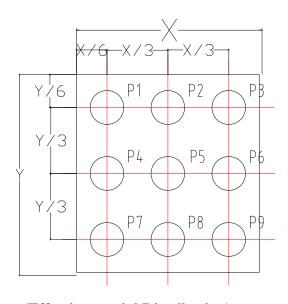
 $(Ta=25^{\circ})$

							(14 25)
PARAMETER	Sym.	Min.	Тур.	Max.	Unit	Test Condition	Note
Supply Current	I	-	20	-	mA	-	
Supply Voltage	V	17.5	20.3	23.1	V	If=20mA	
Reverse Voltage	VR	-	-	5.0	V	-	
Luminous Intensity for LCM	Iv	190	225	-	Cd/m ²		2
Uniformity for LCM	1	70	80	-	%	If=20mA	3
Life Time	-	20000	-	-	Hr.		4
Color				Wh	ite		

NOTE:

- 1. Backlight Only
- 2. Average Luminous Intensity of P1-P9
- 3. Uniformity = Min/Max * 100%
- 4. LED life time defined as follows: The final brightness is at 50% of original brightness

Measured Method: (X*Y: Light Area) Internal Circuit Diagram



CIRCUIT DIAGRAM
B/L Electrical Circuit

 $\mathsf{A} \overset{}{\smile} \overset{}{\smile}_{\mathsf{k}} \overset{$

(Effective spatial Distribution)

Hole Diameter ø7.7 mm; 1 to 9 per Position Measured Luminous



11. Standard Specification for Reliability: 11–1. Standard Specifications for Reliability of LCD Module

No	Item	Description
01	High temperature operation	The sample should be allowed to stand at 70°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation	The sample should be allowed to stand at -20°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage	The sample should be allowed to stand at 80°C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.
04	Low temperature storage	The sample should be allowed to stand at -30°C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage	The sample should be allowed to stand at 60°C,90%RH MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles: -30° C for 30 minutes \rightarrow normal temperature for 5 minutes \rightarrow +80°C for 30 minutes \rightarrow normal temperature for 5 minutes, as one cycle.
07	Packing vibration	Frequency range: 10Hz ~ 55Hz Amplitude of vibration: 1.5mm X,Y,Z 2 hours for each direction. Sweep time: 12 min
08	Packing drop test	According to ISTA 1A 2001.
09	Electrical Static	Air: ± 6 KV 150 pF/ 330Ω 5 times
09	Discharge	Contact: $\pm 4KV \ 150pF/330\Omega \ 5$ time

^{*}Sample size for each test item is 3~5pcs

Module P/N: YB-TG480272S12A-N-D0 Doc.Version:01



11 - 2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 11.2, Standard specifications for Reliability have been executed in order to ensure stability.

No	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

11-3. MTBF

MTBF d c	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (25±5°C), normal humidity (50±10% RH), and in area not exposed to direct sun light.
----------	---

Module P/N: YB-TG480272S12A-N-D0 Doc.Version:01 16



12. Specification of Quality Assurance:

12-1. Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by YEEBO CORPORATION (Supplier).

12-2. Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

c. Test of Appearance Characteristics:

According to the individual specification to test the product.

d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

e. Delivery Test:

Before delivering, the supplier should take the delivery test.

- (i) Test method: According to ISO2859-1.General Inspection Level

 ☐ take a single time.
- (ii) The defects classify of AQL as following:

Major defect: AQL = 0.65% Minor defect: AQL = 2.5% Total defects: AQL = 2.5%

12-3. Non- conforming Analysis & Deal With Manners

- a. Non-conforming Analysis:
- (i) Purchaser should supply the detail data of non- conforming sample and the non-conforming.
- (ii) After accepting the detail data from purchaser, the analysis of non- conforming should be finished in two weeks.
- (iii) If supplier can not finish analysis on time, must announce purchaser before 3 days.
- b. Disposition of non- conforming:
 - (i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.
 - (ii) Both supplier and customer should analyze the reason and discuss the disposition of non-conforming when the reason of nonconforming is not sure.

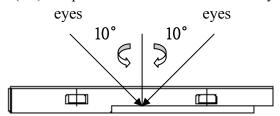
12-4. Agreement items

Both sides should discuss together when the following problems happen.

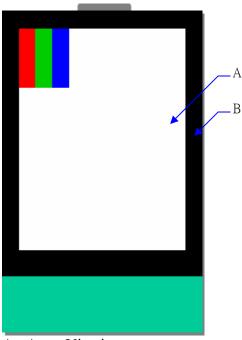
- a. There is any problem of standard of quality assurance, and both sides should think that must be modified
- b. There is any argument item which does not record in the standard of quality assurance.
- c. Any other special problem.



- a. Manner of appearance test:
- (i) The test must be under $20W \times 2$ or 40W fluorescent light, and the distance of view must be at 30 ± 5 cm.
 - (ii) When test the model of transmissive product must add the reflective plate.
 - (iii)The test direction is base on around 10° of vertical line.
 - (iiii)Temperature: 25±5°C Humidity: 60±10%RH



(iv) Definition of area:



- A. Area: Viewing area.
- B. Area: Out of viewing area.

(Outside viewing area)

- b. Basic principle:
- (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (iii) Must add new item on time when it is necessary.
- c. Standard of inspection: (Unit: mm)



12-6. Inspection specification

Defect out of viewing area can be neglected.

NO	Item	Criterion A				
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker			0.65	
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	2.1 Dot dimension as be $\Phi = (X+Y)/2$ $X \leftarrow \frac{1}{Y}$ Y * Dense		Size(mm) $\Phi \le 0.20$ $0.20 < \Phi \le 0.40$ $0.40 < \Phi$	Acceptable Q'ty Accept no dense 5 0	2.5
	LCD and Touch Panel		ely spaced:	Size(mm) $\Phi \le 0.20$ $0.20 < \Phi \le 0.40$ $0.40 < \Phi$ No more than tw	Acceptable Q'ty Accept no dense 5 0	2.5
03	black spots, white spots, contamination (non – display)	* Densely spaced: No more than two	wing draw Length(mm) $L \le 10$ $L \le 10.0$ $L > 10$	ing) Width(mm) $W \le 0.1$ $0.1 < W \le 0.25$ $0.25 < W$	Acceptable Q'ty Accept no dense 4 Rejection Rejection lines within 3mm.	2.5



		Criterion					AQL
04 Polar bubb		If bubbles are visible judge using black sponsore specifications, not ear to find, must check specify direction	ot sy in	Size Φ (m) $\Phi \leq 0.20$ $0.20 < \Phi \leq$ $0.50 < \Phi \leq$ $1.00 < \Phi$ Total Q'ty	≤ 0.50 ≤ 1.00	Accept n 4 3 0 4	 2.5
05 Scrat	tches	Follow NO.3 -2 Line	Type.				
06 Chip glass	-	Symbols: x: Chip length k: Seal width L: Electrode pad leng 6.1 General glass chi 6.1.1 Chip on panel s z: Chip thickness $Z \le 1/2t$ 1/2t< $z \le 2t$ ① Unit: mm ① If there are 2 or n 6.1.2 Corner crack: z: Chip thickness $Z \le 1/2t$ 1/2t< $z \le 2t$ ② Unit: mm ① If there are 2 or n If there are 2 or n	y: Chip width Not over view area Not exceed 1. y: Chip width Not over view area Not exceed 1. Not over view area Not over view area Not exceed 1.	ck between wing wing wing wing wing wing wing win	x: Chip $x \le 1/8a$ ength of $x \le 1/8a$ $x \le 1/8a$ $x \le 1/8a$ $x \le 1/8a$	length e ach chir	2.5

NO	Item	Criterion	AQL
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:	
		y: Chip width x: Chip length z: Chip thickness	
		$y \le 0.5 \text{mm} \qquad x \le 1/8 \text{a} \qquad 0 < z \le t$	
		7.2.2 Non-conductive portion:	
07	Glass crack	y Chin width w Chin length Z: Chip	2.5
		y: Chip width x: Chip length z : Chip thickness $y \le L$ $x \le 1/8a$ $0 < z \le t$	
		$y \le L \qquad \qquad x \le 1/8a \qquad \qquad 0 < z \le t$	
		 If there chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. If the product will be heat sealed by the customer, the alignment mark must mot be damaged. 7.2.3 Substrate protuberance and internal crack y: width x: length 	
		$y = 1/3L$ $X \le a$	
		y = 1/3L $A = a$	



NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	 9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't light or color is wrong. 	2.5 2.5 0.65
10	Bezel	Bezel must comply with product specifications.	2.5
11	PCB · COB	11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart.	2.5 2.5 2.5 2.5 0.65
12	FPC	12.1 FPC terminal damage $\leq 1/2$ FPC terminal width and can not affect the function, we judge accept. 12.2 FPC alignment hole damage $\leq 1/2$ alignment area and can not affect the function, we judge accept.	2.5 2.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle.13.2 No short circuits in components on PCB or FPC.	2.5 0.65

NO	Item	Criterion			A	\QL
NO	Item	Symbols: x: Chip length k: Seal width length L: Electrode pad len 14.1 General glass c	t: Touch Panel Total gth			QL_
	Touch Panel	z: Chip thickness Z≦t	y: Chip width ≤ 1/2 k and not over viewing area	x : Chip length $x \le 1/8a$		
14	Chipped glass	 Unit: mm If there are 2 or 1 14.1.2 Corner crack:	more chips, x is the total	length of each chip	2.	.5
		z: Chip thickness	y: Chip width	x: Chip length		
		z≦t	$\leq 1/2$ k and not over viewing area	x ≤ 1/8a		
		 Unit: mm If there are 2 or 1	more chips, x is the total	length of each chip		



NO	Item	Criterion	AQL
15	Touch Panel(Fish eye)	$\begin{array}{ c c c c }\hline SIZE(mm) & Acceptable Q'ty \\ L \leq 0.7 & Accept no dense \\ L \\ L > 0.7mm & 0 \\ \hline \end{array}$	2.5
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion($\leq 2.5\%$), it is acceptable.	2.5
17	Touch Panel Linearity	Less than 2.5% is acceptable.	
18	LCD Ripple	Touch the touch panel, can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	
19	General appearance	 19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet. 	



13. Handling Precaution:

13-1 Handling of LCM

- Don't give external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance. Must not lick and swallow. when the liquid is attach to your hand, skin, cloth etc. Wash it out thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

13-2 Storage

- Store in an ambient temperature of 25±10°C, and in a relative humidity of 50±10%RH. Don't expose to sunlight or fluorescent light.
- Storage in a clean environment, free from dust, active gas, and solvent.
- Store in anti-static electricity container.
- Store without any physical load.

13-3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: No higher than 280±10°C and less than 3 sec during Hand soldering.
- Rewiring: no more than 2 times.

14. Guarantee:

Our products meet requirements of the environment.

YEEBO ROHS requirement is based on European Union Directive 2011/65/EU (ROHS) Requirements and Update.

Module P/N: YB-TG480272S12A-N-D0 Doc.Version:01 25